

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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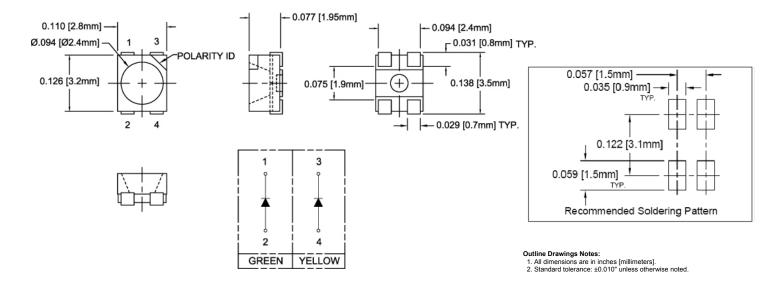
- Industry Standard PLCC4 Footprint
- ♦ 2 Chips in One Low Profile Package
- High Luminous Intensity
- Wide Viewing Angle
- High Power Efficiency



Bivar SMP4 Bi-Color LED combines two chips in a single package and is offered in an industry standard PLCC4 footprint. The SMP4 LED has a water clear lens for high luminous intensity and wide viewing angle making them ideal for small scale applications such as illumination, general indication, and backlighting. The robust package is ideal for harsh working environments and can be clustered in LED arrays for high luminous applications. Low power consumption and excellent long life reliability are suitable for battery powered equipment. Bivar SMP4 LED is packaged in standard tape and reels for pick and place assemblies.

Part Number	Material	Emitted Color	Lumen Typ. mcd	Lens Color	Viewing Angle	
SMP4-BC-YG	GaAsP	Yellow	16	Water Clear	120°	
	GaP	Green	40	vvalei Cleai		

#### **Outline Dimensions**









CAUTION: LOOKING DIRECTLY AT LED WITHOUT SHIELDED EYES MAY CAUSE DAMAGE TO RETINA.



### **Absolute Maximum Ratings**

 $T_A = 25$ °C unless otherwise noted

Power Dissipation	72 mW
Continuous Forward Current	30 mA
Peak Forward Current <sup>1</sup>	100 mA
Reverse Voltage	5 V
Electrostatic Discharge Classification (HBM)	2000 V
Derating Linear From 25°C	0.4 mA/°C
Operating Temperature Range	-40 ~ +85°C
Storage Temperature Range	-40 ~ +100°C
Soldering Temperature <sup>2</sup>	260°C

Notes: 1. 10% Duty Cycle, Pulse Width ≤ 0.1 msec.

### **Electrical Characteristics**

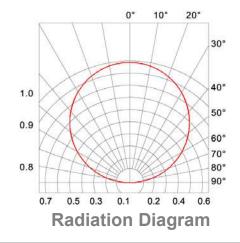
 $T_A = 25$ °C &  $I_F = 20$  mA unless otherwise noted

Emitting Color		ward ge (V)¹	Recommend Forward Current (mA)	Reverse Current (μA) V <sub>R</sub> =5V	Dominant Wavelength (nm) <sup>2</sup>	Lumi Intensity	nous y (mcd) <sup>3</sup>	Viewing Angle 2 Θ ½ (deg)
	TYP	MAX	TYP	MAX	TYP	MIN	TYP	TYP
Yellow	1.9	2.4	20	10	585	10	16	120
Green	1.9	2.4	20	10	570	20	40	120

Notes: 1. Tolerance of Forward Voltage: ±0.05V.

### **Directivity Radiation**

 $T_A = 25$ °C unless otherwise noted



<sup>2.</sup> Solder time less than 5 seconds at temperature extreme.

<sup>2.</sup> Tolerance of Dominant Wavelength: ±0.1nm.

<sup>3.</sup> Tolerance of Luminous Intensity: ±15%.



### Typical Electrical / Optical Characteristics Curves

 $T_A = 25$ °C unless otherwise noted

Relative Spectrum Emission  $I_{rel} = f(I)$ ,  $T_A = 25$ °C ,  $I_F = 20$  mA V(I) = Standard eye response curve

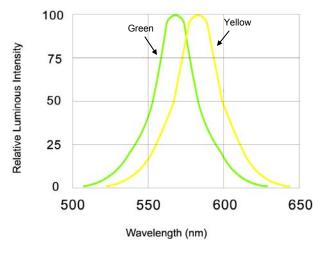
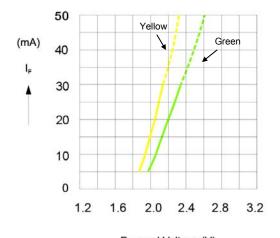


Fig.1 Relative Luminous Intensity vs. Wavelength

Forward Current  $I_F = f(V_F)$  $T_A = 25$ °C



Forward Voltage (V)
Fig.2 Forward Current vs. Forward Voltage

Relative Luminous Intensity  $I_v/I_v$  (20 mA) = f ( $I_F$ )  $T_A$  = 25°C

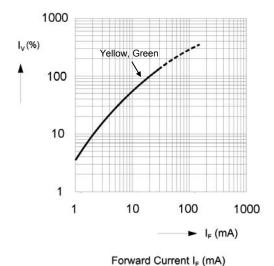
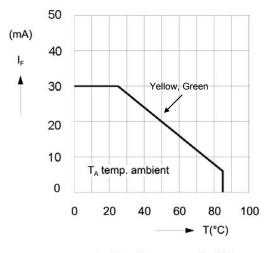


Fig.3 Relative Luminous Intensity vs. Forward Current

Ambient Temperature vs. Allowable Forward Current

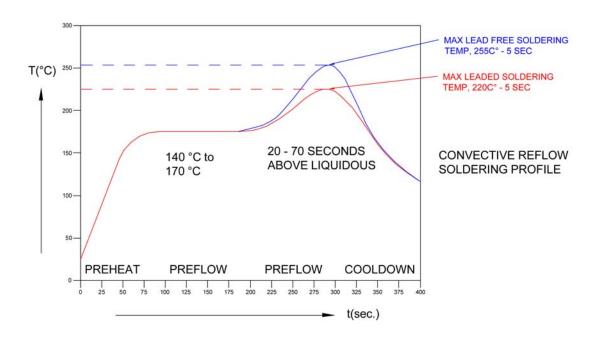


Ambient Temperature T<sub>A</sub> (°C)

Fig.4 Forward Current vs. Ambient Temperature

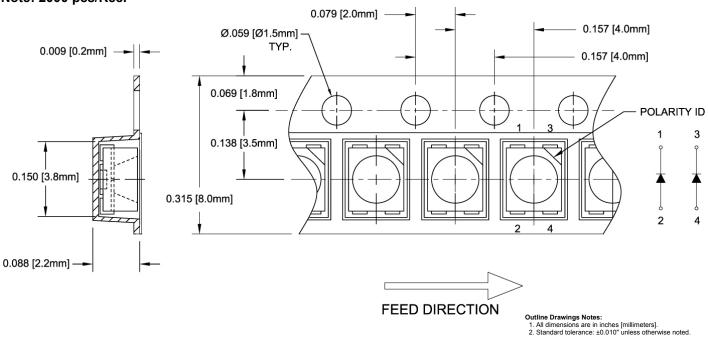


### **Recommended Soldering Conditions**

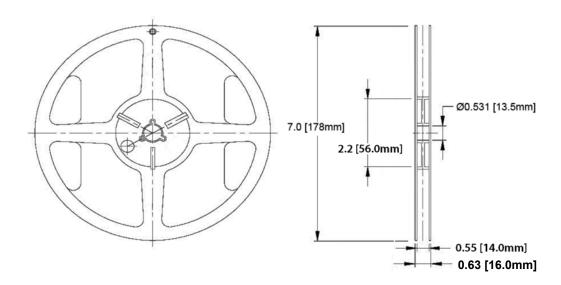


### Tape and Reel Dimensions

Note: 2000 pcs/Reel







#### **Outline Drawings Notes:**

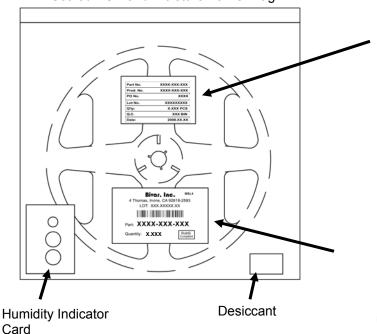
- 1. All dimensions are in inches [millimeters].
- 2. Standard tolerance unless otherwise noted: X.XXX ± 0.010"

X.X ± 0.1"

### **Packaging and Labeling Plan**

Note: 1 Reel / Bag

#### Sealed ESD and Moisture Barrier Bag



Part No.	XXXX-XXX-XXX			
Prod. No.	XXXX-XXX-XXX			
PO No.	xxxx			
Lot No.	xxxxxxxx			
Q'ty:	X.XXX PCS			
Q.C.	XXX BIN			
Date:	2008.XX.XX			

Internal Quality Control Label

#### MSL4 Bivar. Inc.

4 Thomas, Irvine, CA 92618-2593 LOT: XXX.XXXXXXXX



Part: XXXX-XXX

Quantity: X,XXX

RoHS Compliant

Bivar Standard Packaging Label